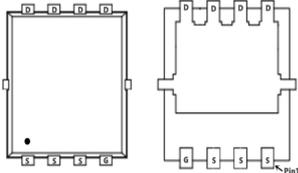
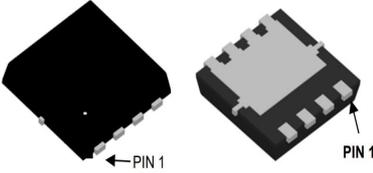
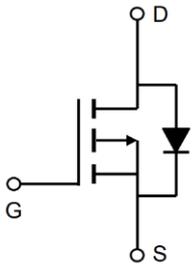


**TM80P04NF**

**P-Channel Enhancement Mosfet**

<p><b>General Description</b></p> <ul style="list-style-type: none"> <li>• Low <math>R_{DS(ON)}</math></li> <li>• RoHS and Halogen-Free Compliant</li> </ul> <p><b>Applications</b></p> <ul style="list-style-type: none"> <li>• Load switch</li> <li>• PWM</li> </ul>	<p><b>General Features</b></p> <p><math>V_{DS} = -40V</math> <math>I_D = -80A</math>  <math>R_{DS(ON)} = 4.3m\Omega (typ.) @ V_{GS} = -10V</math></p> <p>100% UIS Tested                  100% <math>R_g</math> Tested</p> 
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NF:DFN5x6-8L

Marking: 80P04

**Absolute Maximum Ratings** ( $T_A = 25^\circ C$  Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit s
$V_{DS}$	Drain-Source Voltage	-40	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ -10V^{1,6}$	-80	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ -10V^{1,6}$	-50.6	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	-280	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	576	mJ
$I_{AS}$	Avalanche Current	-56	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation <sup>4</sup>	58	W
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 175	$^\circ C$

**Thermal Data**

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient <sup>1</sup> ( $t \leq 10S$ )	---	20	$^\circ C/W$
	Thermal Resistance Junction-ambient <sup>1</sup> (Steady State)	---	50	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-case <sup>1</sup>	---	1.6	$^\circ C/W$

**TM80P04NF**

**P-Channel Enhancement Mosfet**

**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

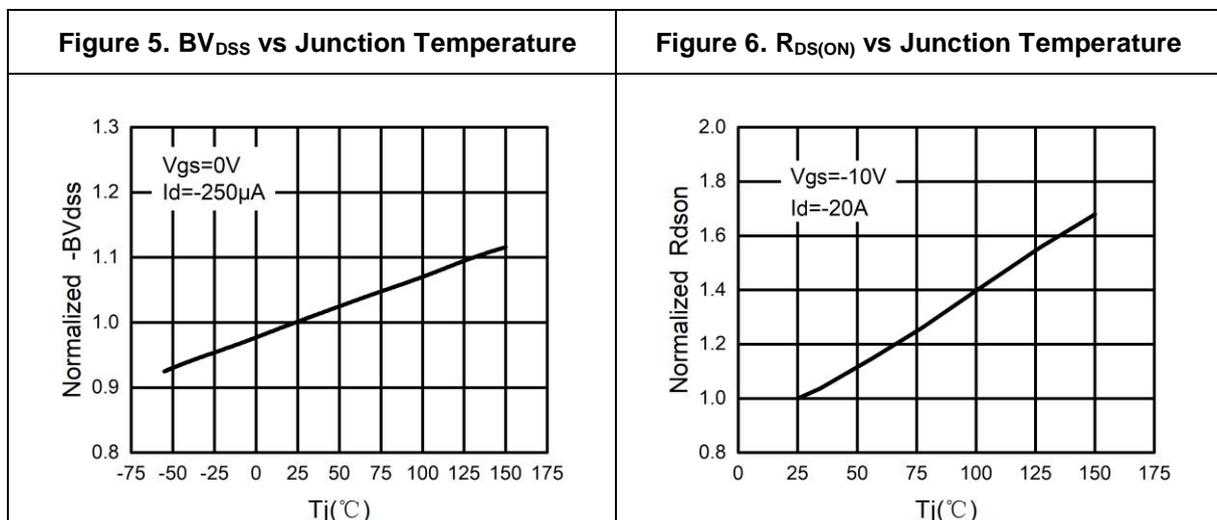
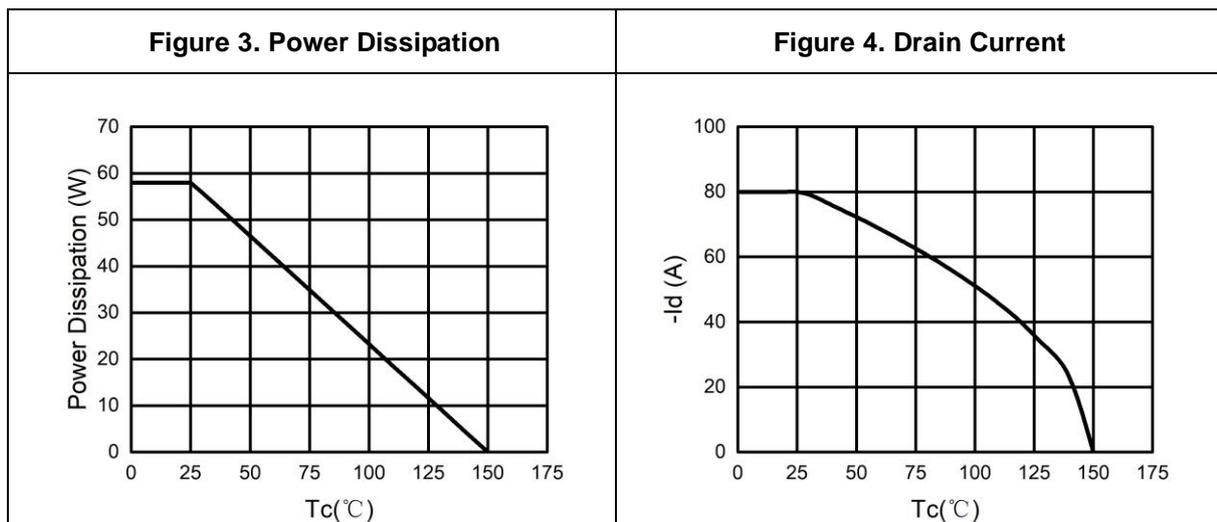
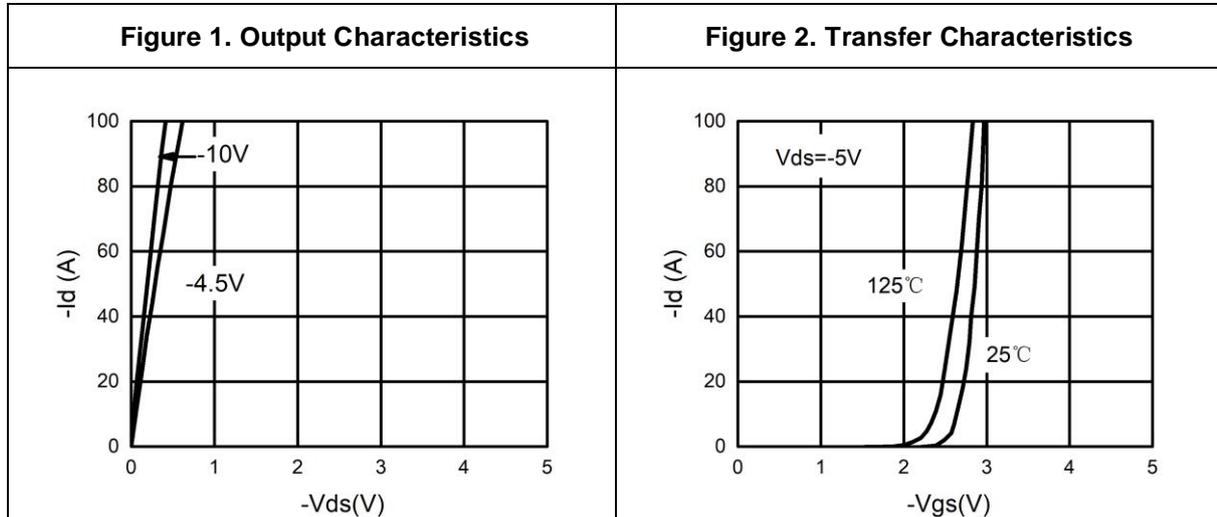
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
B <sub>V</sub> DSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-40			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-40V, V <sub>GS</sub> =0V			-1	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-1	-1.7	-2.5	V
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =-5V, I <sub>D</sub> =-20A		63		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A		4.3	5.8	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-20A		5.9	7.6	mΩ
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V, f=1.0MHz		6638		pF
C <sub>oss</sub>	Output Capacitance			545		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			345		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		2.2		Ω
<b>Switching Parameters</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-20V, R <sub>L</sub> =1Ω, R <sub>GEN</sub> =3Ω		16		nS
t <sub>r</sub>	Turn-on Rise Time			17		nS
t <sub>d(off)</sub>	Turn-Off Delay Time			68		nS
t <sub>f</sub>	Turn-Off Fall Time			31		nS
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-20V, I <sub>D</sub> =-20A		118		nC
Q <sub>gs</sub>	Gate-Source Charge			13		nC
Q <sub>gd</sub>	Gate-Drain Charge			22		nC
<b>Source-Drain Diode Characteristics</b>						
I <sub>SD</sub>	Source-Drain Current (Body Diode)				-80	A
V <sub>SD</sub>	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =-20A			-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =-20A, di/dt=500A/μs		24		ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> =-20A, di/dt=500A/μs		140		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E<sub>AS</sub> condition: T<sub>J</sub>=25 °C, V<sub>DD</sub>=15V, V<sub>G</sub>=-10V, R<sub>G</sub>=25Ω, L=0.5mH.

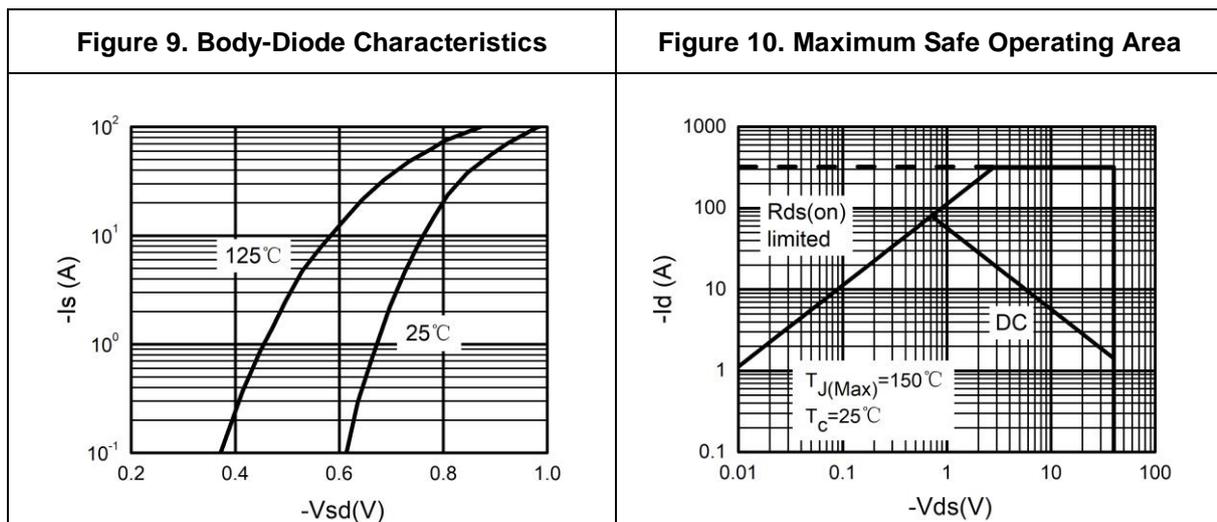
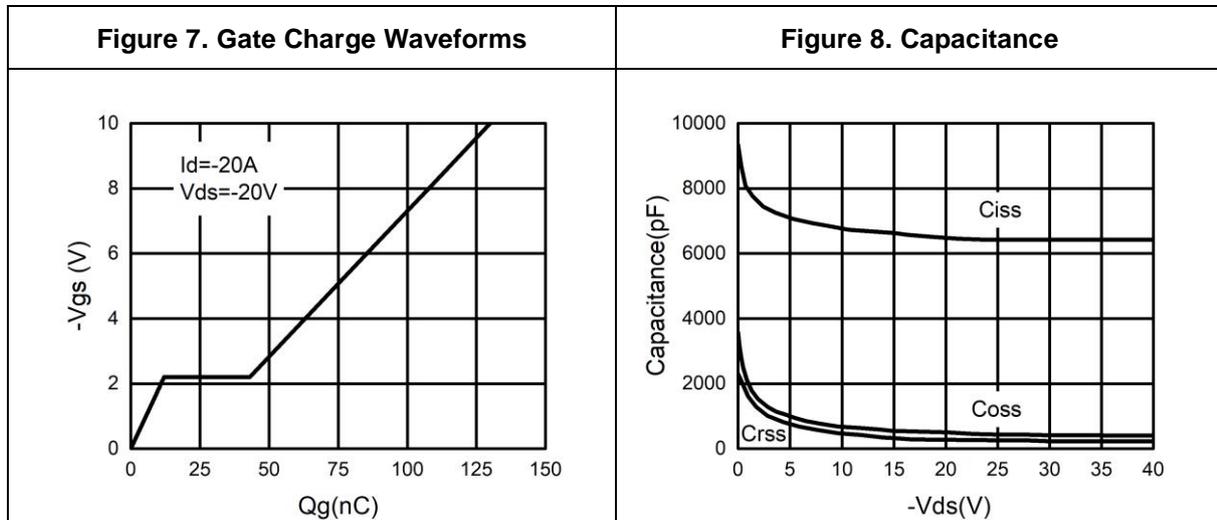
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

Typical Electrical And Thermal Characteristics (Curves)



TM80P04NF

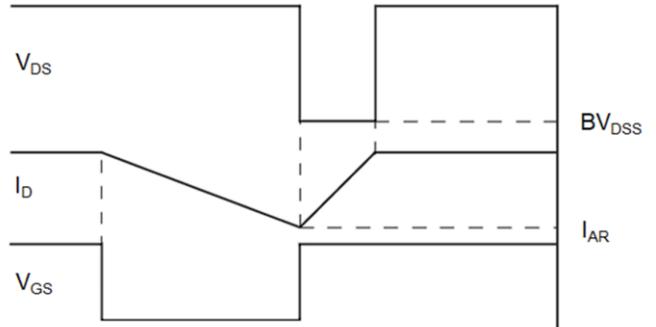
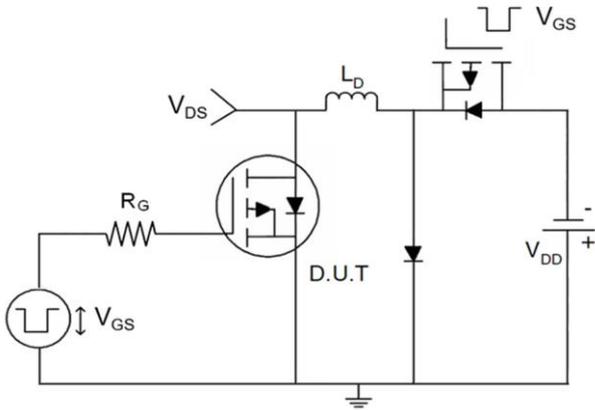
P-Channel Enhancement Mosfet



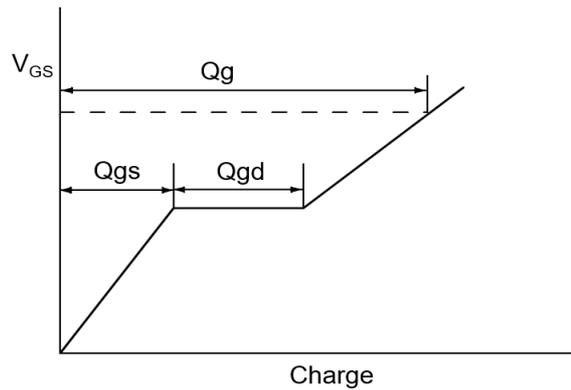
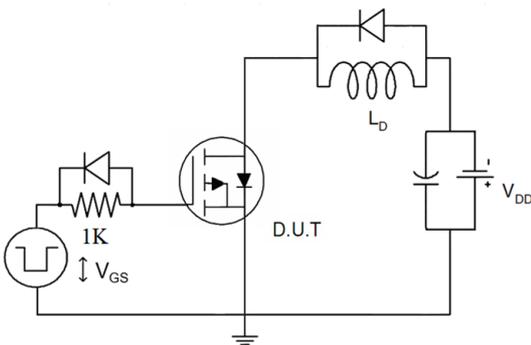
TM80P04NF

P-Channel Enhancement Mosfet

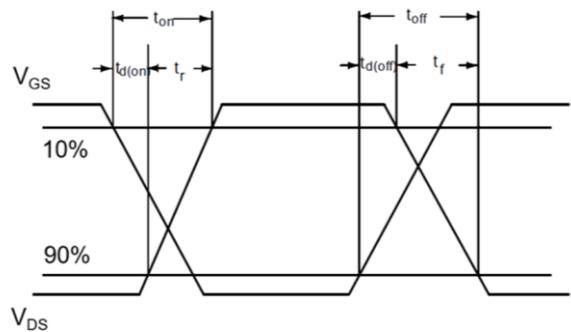
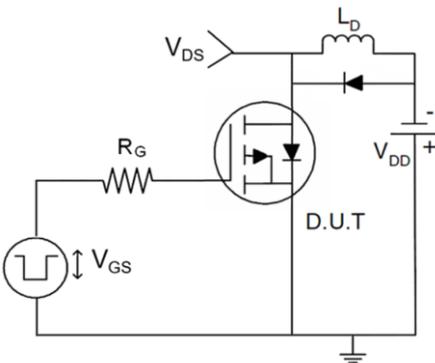
1)  $E_{AC}$  Test Circuits



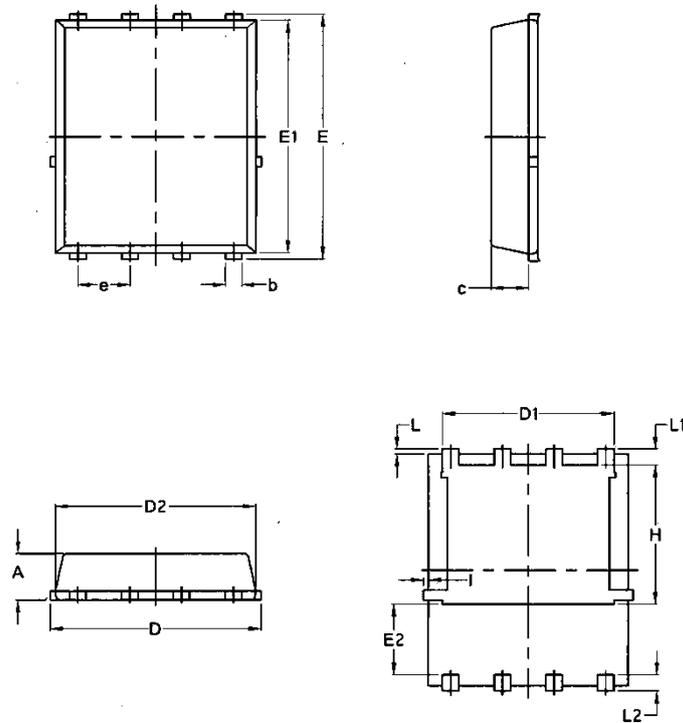
2) Gate Charge Test Circuit



3) Switch Time Test Circuit



## Package Mechanical Data: DFN5x6-8L



Symbol	Common			
	mm		Inch	
	Min	Max	Min	Max
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.0970	0.0324	0.082
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	/	0.18	/	0.0070